



Docket Number: 1133279-0017

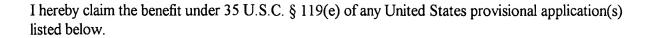
DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

CRIMPING	INTRALUMINA	L ENDOPROSTHESIS HAVING	HELICAL ELEMENTS
the specification of	of which is attached	hereto unless the following box is	checked:
	onal Application Nu	2002 as United States Application and was	n Number <u>10/071,071,</u> amended on
-		nd understand the contents of the a any amendment referred to above.	bove identified specification,
I acknowledge the 37 CFR § 1.56.	duty to disclose in	formation which is material to pate	entability as defined in
application(s) for ywhich designated identified below, b	patent or inventor's at least one country by checking the box	es under 35 U.S.C. § 119(a)-(d) or certificate, or § 365(a) of any PCT other than the United States, lister, any foreign application for patent ying a filing date before that of the	Tinternational application d below and have also or inventor's certificate, or of
Prior Foreign App	lication(s)		Priority Not Claimed
97201799.0	EP	13 June 1997	
Number	Country	Day/Month/Year Filed	
98201446.6	EP	06 May 1998	
Number	Country	Day/Month/Year Filed	



60/267,778	09 FEBRUARY 2001
(Application Number)	(Filing Date)

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or § 365(c) of any PCT international application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

09/511,481	23 February 2000	Pending	
(Application Number)	(Filing Date)	(Statuspatented, pending, abandoned)	
09/094,402	10 June 1998	Patented (6,117,165)	
(Application Number)	(Filing Date)	(Statuspatented, pending, abandoned)	

I/we hereby appoint Practitioners at Customer Number 007470 as my/our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

Address all correspondence to <u>Customer No. 007470</u>

Telephone No.: 212-819-8200; Facsimile No.: 212-354-8113

Direct Telephone Calls To: John M. Genova, Esq. - (212)-819-8832

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believe to be true; and further that these statements

were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of first inventor (first name, middle initial last name): John D. Pazienza					
Sole or first inventor's signature	Date: 15-FED - 02				
Residence: Pompano Beach, Florida	Citizenship: <u>US</u>				
Post Office Address: 650 SE 5 th Terrace <u>Pompano Beach, Florida 33060</u>					
Full name of second inventor (first name, middle initial, last name)					
Second inventor's signature	Date: 3-6-02				
Residence: Plantation, Florida	Citizenship: <u>US</u>				
Post Office Address: 6040 S.W. 13 th Street <u>Plantation, Florida</u> 33317					
Full name of third inventor (first name, middle initial, last name): Gary J. Becker Third inventor's signature Date: 2/14/02					
Residence: Miami, Florida	Citizenship: <u>US</u>				
Post Office Address: 5925 SW 107 th Street Miami, Florida 33156					